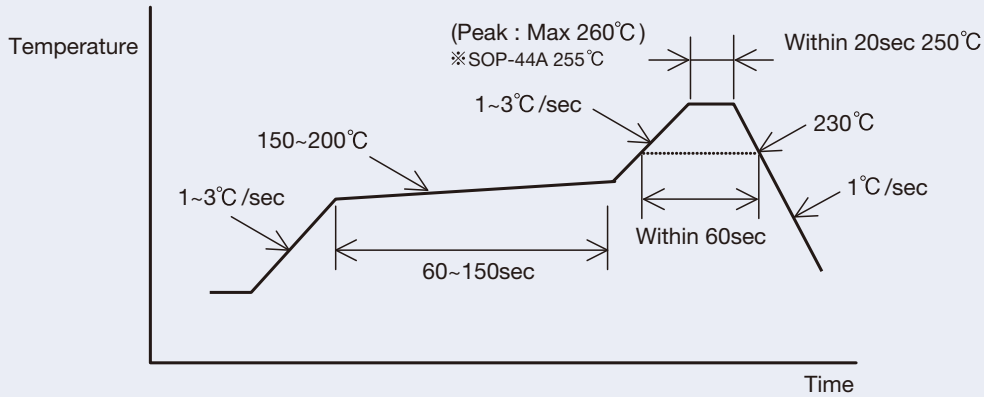
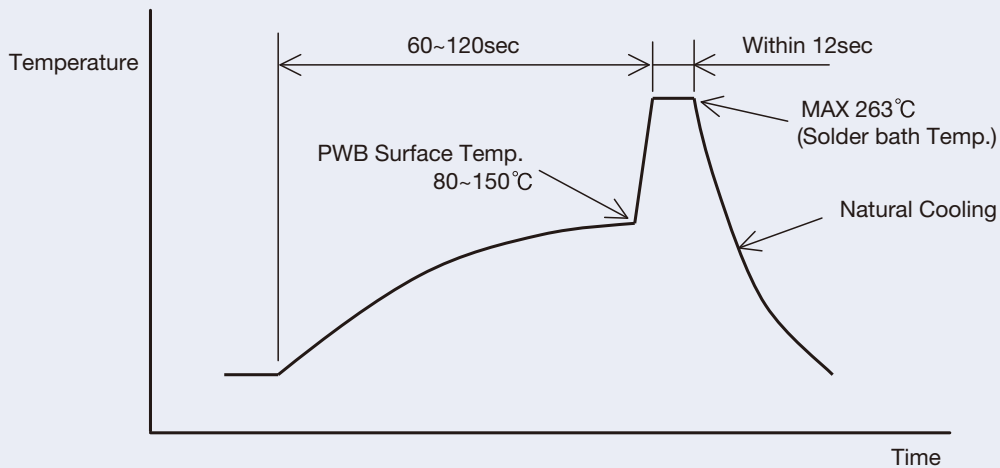


# 无铅产品

## Reflow Soldering (max 2times)



## Flow Soldering (max 1times)



Note : In case of double-wave soldering, the temp. is at its peak during the total time of 2max. temp..

## Manual Soldering

Iron tip temp./time	times
max 400°C/3s	max 2

## Pre Treatment Moisture Soaking Condition of Reliability Test

85°C 65%RH 168h (1st) 、 85°C 65%RH 168h (2nd)

note : Please contact us for the CSP package separately.

## 各封装的实装次数

封装	回流焊次数	波峰焊次数	手工焊
TO-92A		1	2
SON-6A	2		2
SON-6B	2		2
SON-6C	2		2
SON-6D	2		2
SOT89-5A	2		2
SC-82ABA	2	1	2
SC-82ABB	2	1	2
SC-88A	2	1	2
SOT-23A	2	1	2
SOT-25A	2	1	2
SOT-26A	2	1	2
SOT-26B	2	1	2
SOP-7B	2	1	2
SOP-8D	2	1	2
SOP-16B	2	1	2
SOP-28B	2	1	2
SOP-44A	2 <sup>※1</sup>	1	2
SSOP-8A	2	1	2
SSOP-24B	2	1	2
SSOP-36A	2	1	2
SSOP-42A	2	1	2
TSOP-16A	2		2
TSOP-16B	2		2
TSOP-20A	2		2
TSOP-20C	2		2
TSOP-20D	2		2
TSOP-20E	2		2
VSOP-8B	2		2
HSOP-8A	2		2
HSOP-28A	2	1	2
HSOP-28C	2	1	2
HSOP-36A	2	1	2
QFP-64E	2 <sup>※2</sup>		2
QFP-80D	2 <sup>※1</sup>		2
QFP-100A	2 <sup>※1</sup>		2
TO-252C	2		2
TO-252-5A	2		2
PLP-4A	2		
PLP-4B	2		
PLP-6A	2		
PLP-10A	2		
SQFN-16A	2		
SQFN-32A	2		
SSON-4B	2		
SSON-6A	2		
SSON-6E	2		
SSON-6J	2		
SSON-8B	2		

※1 由于不同于标准的温度曲线图，因此请单独咨询。

※2 由于是防湿包装，因此开封后请在168小时内进行实装，第2次以后的间隔也要在168小时以内。